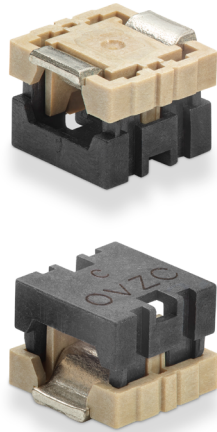


HC RTP-mini-C

Reflowable Thermal Protectors



Description

High Current Reflowable Thermal Protection Mini (HC RTP-MINI-C) Device is a low-resistance, robust surface mountable thermal protector. It has a set open temperature and can be installed using reliable, lead-free, Surface Mount Device (SMD) assembly and reflow processes.

The HC RTP-MINI-C device, recently added to the RTP family, can help withstand the demanding environmental, life and reliability requirements of automotive and industrial applications, including shock, vibration, temperature cycling and humidity exposures. In the field, the HC RTP-MINI-C device opens if its internal junction exceeds the device's specified open temperature. Temperature increases can have multiple sources, one of which is component failure (e.g., when using power components such as a powerFET, capacitor, resistor, triac, etc.) The HC RTP-MINI-C device open temperature is selected so that the device does not open within normal component operating windows, but it does open in a thermal runaway event and before the melt temperature of typical lead-free solders.

Applications

- Automotive HVAC, ABS, power steering, DC/DC converters, diesel heaters, engine cooling fans, body control modules, PTC heaters, etc.
- IT servers, telecom power converters, etc.
- Other industrial applications with high demanding environmental, life and reliability requirements
- Other DC thermal protection

[See Disclaimer Notice](#)

Features & Benefits

- Capable of high hold current
- Low profile, compact footprint
- Compatible with SMD solder reflow process up to 260°C
- Low series resistance; DC interrupt voltage capable
- Helps prevent failed components from causing damage in case of a thermal event
- Allows the use of standard surface-mount production methods so that no special assembly costs are required
- Low power dissipation and voltage drop
- Supports DC electronic circuits
- AEC-Q200 qualified

Additional Information



Resources



Samples

Specifications

Voltage Rating:	500A @ 16 VDC
Interrupting Rating:	16 VDC
Operating Temperature Range:	-55°C to + 150°C
Initial Resistance:	53μΩ Min, 91μΩ Max

HC RTP-mini-C

Reflowable Thermal Protectors

Ordering Information

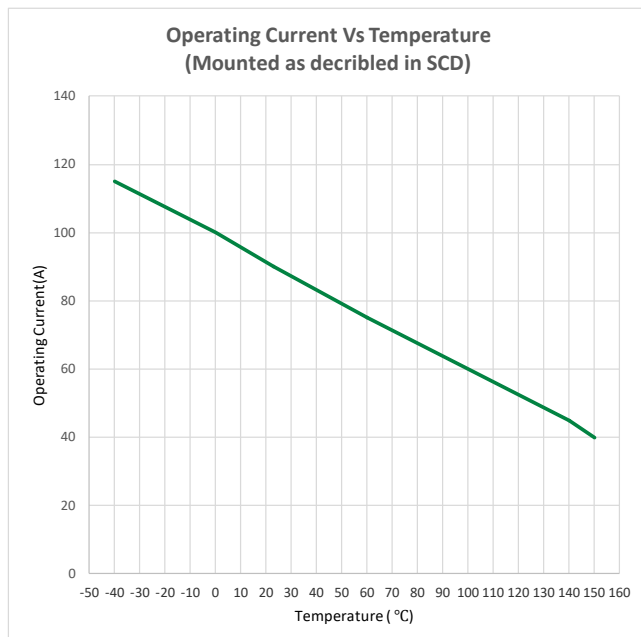
Part Number	Part Description	Package Size
RF4678-000	HC RTP-MINI-C	4000

Referenced Performance

Results obtained on 44.4mm x 57.2 mm x 1.6mm of 2-sided FR4 board T4485 with 4.0 oz. Copper Trace. HC RTP-mini-C device surface-mounted on test board T4485 using solder paste SAC 305 with recommended pad layout and solder stencil opening and thickness. Post reflow resistance based on SMT 1x reflow as outlined in solder reflow recommendation. Results are highly installation-dependent. Users should confirm for their own application.

Performance		Min	Typ.	Max	Units
Post Reflow Resistance*	@ 23+/-3°C	60	110	160	μΩ
	@ 150+/-3°C	120	165	210	
Hold Current	@ 23+/-3°C			90	A
	@ 140+/-3°C			45	
Max Interrupt Current	16 VDC			500	A
Open Temperature	Zero Bias	212	220	228	°C

*Post reflow Resistance should be measured by a 4 wired method



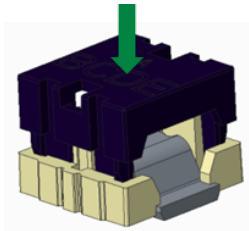
* Halogen Free refers to: Br≤900ppm, Cl≤900ppm, Br+C≤1500ppm.

HC RTP-mini-C

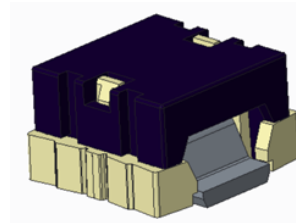
Reflowable Thermal Protectors

Arming method

Arming is to occur after surface mount installation. **Method:** Cap depressed manually or by mechanical plunger.



Downward force required for mechanical arming



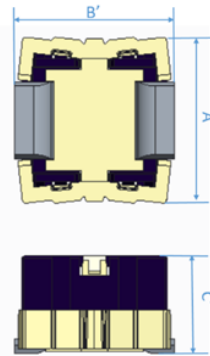
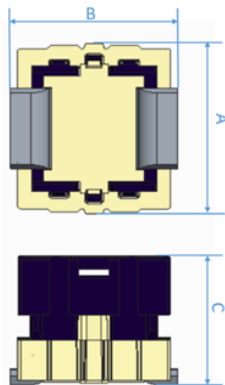
Device after mechanical arming completed

Warning: The device will not function without proper arming. If the device will be depressed by mechanical plunger, the plunger speed should be verified in the user's process.

Description	Min.	Typ.	Max.	Units
Arming Force (Normal to PCB surface)	25	32.5	40	N
Distance of travel	0.94	1.00	1.06	mm

Dimensions

Dimensions in mm.



Before Mechanical Arming

	A		B		C	
	Min	Max	Min	Max	Min	Max
mm	6.14	7.14	6.10	7.10	4.80	5.20
in	0.242	0.281	0.240	0.280	0.189	0.205

After Mechanical Arming

	A'		B'		C'	
	Min	Max	Min	Max	Min	Max
mm	6.83	7.83	6.10	7.10	3.80	4.20
in	0.269	0.308	0.240	0.280	0.150	0.165

Rev 11162023

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